



DATA SHEET

SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS High Frequency Automotive Grade

NP0

I6 V TO 50 V 0.2 pF to 100 pF RoHS compliant & Halogen Free



YAGEO Phícomp

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Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade 2

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<u>SCOPE</u>

This specification describes Automotive grade NPO series chip capacitors with lead-free terminations and used for automotive equipments.

APPLICATIONS

All general purpose applications Entertainment applications Comfort / security applications Information applications

FEATURES

- AEC-Q200 qualified
- MSL class: MSL I
- AC series soldering is compliant with J-STD-020D
- Halogen free epoxy
- RoHS compliant
- Reduce environmentally hazardous waste
- High component and equipment reliability
- The capacitors are 100% performed by automatic optical inspection prior to taping.

ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

NP0

GLOBAL PART NUMBER

AQ <u>XXXX</u> <u>X</u> <u>X</u> <u>XXX</u> <u>X</u> B <u>X</u> <u>XXX</u> (1) (2) (3) (4) (5) (6) (7)

(I) SIZE - INCH BASED (METRIC)

0603 (1608)

(2) TOLERANCE

0.2pF to 2.0pF
$A = \pm 0.05 \text{ pF}$
$B = \pm 0.1 \text{ pF}$
C = ±0.25 pF
2.1 pF to 5.0pF
$A = \pm 0.05 \text{ pF}$
$B = \pm 0.1 \text{ pF}$
C = ±0.25 pF
$D = \pm 0.5 \text{ pF}$
5.1pF to 9.9pF
$B = \pm 0.1 \text{ pF}$
C = ±0.25 pF
$D = \pm 0.5 \text{ pF}$
10pF and over
$F = \pm 1\%$
$G = \pm 2\%$
$J = \pm 5\%$

(3) PACKING STYLE

- R = Paper/PE taping reel; Reel 7 inch
- P = Paper/PE taping reel; Reel 13 inch

(4) TC MATERIAL

NPO

(5) RATED VOLTAGE

- 7 = 16 V 8 = 25 V
- 9 = 50 V

(6) PROCESS

N = NP0

(7) CAPACITANCE VALUE

2 significant digits+number of zeros The 3rd digit signifies the multiplying factor, and letter R is decimal point Example: $121 = 12 \times 10^{1} = 120 \text{ pF}$

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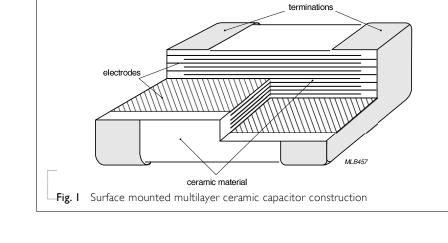
CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (Matte Sn). The terminations are leadfree. A cross section of the structure is shown in Fig. I.

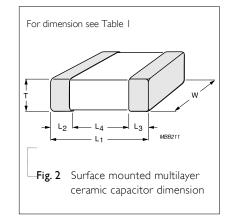
DIMENSION

Table I For outlines see fig. 2



TYPE	L _I (mm)	W (mm)	T (MM)	L ₂ / min.	L ₃ (mm) max.	L ₄ (mm) min.
0603	1.6 ±0.10	0.8 ±0.10	0.8 ±0.10	0.20	0.60	0.40

OUTLINES





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CAPACITANCE RANGE & THICKNESS FOR NPO

	s 0603	<u>s inignite</u>		<u> </u>				
CAP.	0603				CAP.	0603		
	16 V	25 V	50 V			16 V	25 V	50 V
0.2 pF	0.8±0.1	0.8±0.1	0.8±0.1		9 pF	0.8±0.1	0.8±0.1	0.8±0.1
0.3 pF	0.8±0.1	0.8±0.1	0.8±0.1		10 pF	0.8±0.1	0.8±0.1	0.8±0.1
0.4 pF	0.8±0.1	0.8±0.1	0.8±0.1		12 pF	0.8±0.1	0.8±0.1	0.8±0.1
0.5 pF	0.8±0.1	0.8±0.1	0.8±0.1		15 pF	0.8±0.1	0.8±0.1	0.8±0.1
0.6 pF	0.8±0.1	0.8±0.1	0.8±0.1		18 pF	0.8±0.1	0.8±0.1	0.8±0.1
0.7 pF	0.8±0.1	0.8±0.1	0.8±0.1		22 pF	0.8±0.1	0.8±0.1	0.8±0.1
0.8 pF	0.8±0.1	0.8±0.1	0.8±0.1		27 pF	0.8±0.1	0.8±0.1	0.8±0.1
0.9 pF	0.8±0.1	0.8±0.1	0.8±0.1		33 pF	0.8±0.1	0.8±0.1	0.8±0.1
1.0 pF	0.8±0.1	0.8±0.1	0.8±0.1		39 pF	0.8±0.1	0.8±0.1	0.8±0.1
I.2 pF	0.8±0.1	0.8±0.1	0.8±0.1		47 pF	0.8±0.1	0.8±0.1	0.8±0.1
1.5 pF	0.8±0.1	0.8±0.1	0.8±0.1		56 pF	0.8±0.1	0.8±0.1	0.8±0.1
1.8 pF	0.8±0.1	0.8±0.1	0.8±0.1		68 pF	0.8±0.1	0.8±0.1	0.8±0.1
2.0 pF	0.8±0.1	0.8±0.1	0.8±0.1		82 pF	0.8±0.1	0.8±0.1	0.8±0.1
2.2 pF	0.8±0.1	0.8±0.1	0.8±0.1		100 pF	0.8±0.1	0.8±0.1	0.8±0.1
2.4 pF	0.8±0.1	0.8±0.1	0.8±0.1					
2.7 pF	0.8±0.1	0.8±0.1	0.8±0.1					
3.0 pF	0.8±0.1	0.8±0.1	0.8±0.1					
3.3 pF	0.8±0.1	0.8±0.1	0.8±0.1					
3.6 pF	0.8±0.1	0.8±0.1	0.8±0.1					
3.9 pF	0.8±0.1	0.8±0.1	0.8±0.1					
4.0 pF	0.8±0.1	0.8±0.1	0.8±0.1					
4.7 pF	0.8±0.1	0.8±0.1	0.8±0.1					
5.0 pF	0.8±0.1	0.8±0.1	0.8±0.1					
5.6 pF	0.8±0.1	0.8±0.1	0.8±0.1					
6.0 pF	0.8±0.1	0.8±0.1	0.8±0.1					
6.8 pF	0.8±0.1	0.8±0.1	0.8±0.1					
7.0 pF	0.8±0.1	0.8±0.1	0.8±0.1					
8.0 pF	0.8±0.1	0.8±0.1	0.8±0.1					
8.2 pF	0.8±0.1	0.8±0.1	0.8±0.1	-				

NOTE

I. Values in shaded cells indicate thickness class in mm

2. Capacitance value of non E-12 series is on request



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THICKNESS CLASSES AND PACKING QUANTITY

Table 13						
SIZE	THICKNESS		Ø180	MM / 7 INCH	Ø330	MM / 13 INCH
CODE	CLASSIFICATION	QUANTITY PER REEL	Paper	Blister	Paper	Blister
0603	0.8 ±0.1 mm	8 mm	4,000		5,000	

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ELECTRICAL CHARACTERISTICS

NP0 DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

Table I	4	
DESCRIPT	ION	VALUE
Capacitanc	e range	0.2 pF to 100 µpF
Capacitanc	e tolerance	
NP0	C < 10 _P F	± 0.05 pF, ±0.1 pF, ±0.25 pF, ±0.5 pF
	C ≥ 10 pF	±1%, ±2%, ±5%
Dissipation	factor (D.F.)	
NP0	C < 30 _P F	\leq / (400 + 20C)
	C ≥ 30 pF	≤ 0.1 %
Insulation r	resistance after 1 minute at U _r (DC)	$IR \ge 10 \text{ G}\Omega$
	capacitance change as a function of temperature ire characteristic/coefficient):	
NP0		±30 ppm/°C
Operating	temperature range:	
NP0		–55 °C to +125 °C



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SOLDERING RECOMMENDATION . .

Table 15					
SOLDERING METHOD	SIZE 0402	0603	0805	1206	≥ 1210
Reflow	≥0.1 µF	≥ I.0 µF	≥ 2.2 µF	≥ 4.7 µF	Reflow only
Reflow/Wave	< 0.1 µF	< 1.0 µF	< 2.2 µF	< 4.7 µF	

SOLDERING CONDITIONS

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C ٠
- Endurance: 95 to 120 seconds ٠
- Cycles: 3 times

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202F-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 270 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

TESTS AND REQUIREMENTS

TEST	TEST METH	IOD	PROCEDURE	REQUIREMENTS
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage
Capacitance	IEC 60384- 21/22	4.5.I	Class I: At 20 °C, 24 hours after annealing $f = 1 \text{ MHz}$ for $C \le 1 \text{ nF}$, measuring at voltage 1 V _{rms} at 20 °C f = 1 KHz for $C > 1 nF$, measuring at voltage 1 V _{rms} at 20 °C	Within specified tolerance
Dissipation Factor (D.F.)	IEC 60384- 21/22	4.5.2	Class I: At 20 °C, 24 hours after annealing $f = 1 \text{ MHz}$ for $C \le InF$, measuring at voltage 1 V _{rms} at 20 °C f = 1 KHz for $C > InF$, measuring at voltage 1 V _{rms} at 20 °C	In accordance with specification
Insulation Resistance	IEC 60384- 21/22	4.5.3	At U _r (DC) for 1 minute	In accordance with specification

TEST	TEST METHO) PROCE	DURF	REQUIREMENTS
Temperature coefficient	4.	5 Capacita the follo The cap min at e Step a b c d e (1) Clas Temper formula Temp, C C1: Cap C2: Cap Δ T: 100 (2) Clas Capacita formula Δ C = $\frac{C}{2}$	ance shall be measured by the steps shown in wing table. acitance change should be measured after 5 ach specified temperature stage. Temperature(°C) 25±2 Lower temperature±3°C 25±2 Upper Temperature±2°C 25±2 s I ature Coefficient shall be calculated from the as below Coefficient = $\frac{C2 - CI}{CI \times \Delta T} \times 10^6$ [ppm/°C] acitance at step c acitance at 125°C 0°C(=125°C-25°C)	 <general purpose="" series=""> Class I:</general> Δ C/C: ±30ppm
High Temperature Exposure	AEC-Q200 3		ered ; 1000hours @ T=150° C ement at 24±2 hours after test conclusion.	No visual damage Δ C/C : Class I: NPO: within ±0.5% or 0.5 pF whichever is greater
Temperature Cycling	AEC-Q200 4	24 ±1 h 1000 cy 30 minu	litioning; 10 °C for 1 hour, then keep for ours at room temperature cles with following detail: tes at lower category temperature tes at upper category temperature	No visual damage ΔC/C Class I : NP0: Within ±1% or 0.5pF, whichever is greater.

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16 V to 50 V

NP0

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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Moisture Resistance	AEC-Q200 6	T=24 hrs/per cycle; 10 continuous cycles unpowered. Measurement at 24 \pm 2 hours after test condition.	No visual damage
			$\Delta C/C$ NP0: Within ±3% or 3 pF, whichever is greater
			D.F. Within initial specified value IR NP0: \geq 10,000 M Ω
Fig. 4 Moisture	b5 DITIO 60 A ORY 55 24 HOU 55 45 40 UNCONT 35 45 10 35 20 INITIAL 15 55 0 5 0 5 -10 5 -10 9 9 10 9 10		STEP 7
Biased Humidity	AEC-Q200 7	 I. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp 	No visual damage after recovery
		 Initial measure: Parameter: IR Measuring voltage: 1.5V ± 0.1 VDC Note: Series with 100 KΩ & 6.8 KΩ Test condition: 85 °C, 85% R.H. connected with 100 KΩ resistor, applied 1.5V/U_r for 1,000 hours. Recovery: Class1: 6 to 24 hours Class2: 24 ±2 hours 	Initial requirement: Class I: - Connected to 100 K Ω : C ≤ 10 nF: 1.R ≥ 10,000 M Ω or C > 10 nF: (1.R-100 K Ω) × C ≥ 100s. - Connected to 6.8 K Ω : C ≤ 10 nF: 1.R ≥ 10,000 M Ω or C > 10 nF: (1.R-6.8 K Ω) × C ≥ 100s.
		5. Final measure: IR	Final measurement: The insulation resistance shall be

The insulation resistance shall be greater than 0.1 time initial value.

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REQUIREMENTS TEST TEST METHOD PROCEDURE **Operational Life** AEC-Q200 8 No visual damage I. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for $\Delta C/C$ 24 ±1 hour at room temp NPO: Within ±2% or 1 pF, whichever 2. Initial measure: is greater Spec: refer to initial spec C, D, IR 3. Endurance test: D.F. Specified stress voltage applied for 1,000 hours: NP0: $\leq 2 \times$ specified value. Applied 2.0 \times U_r for general products IR 4. Recovery time: 24 ±2 hours NP0: \geq 4,000 M Ω or IR \times C_r \geq 40s 5. Final measure: C, D, IR whichever is less Note: If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirement shall be met. **External Visual** AEC-Q200 9 Any applicable method using × 10 magnification In accordance with specification Physical 10 AEC-Q200 Verify physical dimensions to the applicable device In accordance with specification Dimension specification. Mechanical AEC-Q200 13 $\Delta C/C$ Three shocks in each direction shall be applied along Shock NP0: Within ±0.5% or 0.5 pF, the three mutually perpendicular axes of the test whichever is greater specimen (18 shocks) Peak value: 1,500 g's Duration: 0.5 ms D.F. Velocity change: 15.4 ft/s Within initial specified value Waveform: Half-sin IR Within initial specified value Vibration AEC-Q200 14 $\Delta C/C$ 5 g's for 20 minutes, 12 cycles each of 3 orientations. NP0: Within ±0.5% or 0.5 pF, Note: whichever is greater Use 8'' \times 5'' PCB. 0.31'' thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. D.F: meet initial specified value Test from 10-2000 Hz. IR meet initial specified value Resistance to AEC-Q200 15 Precondition: 150 +0/-10 °C for 1 hour, then keep for Dissolution of the end face plating Soldering Heat 24 ±1 hours at room temperature shall not exceed 25% of the length of the edge concerned Preheating: for size ≤ 1206: 120 °C to 150 °C for 1

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TEST	TEST METH	IOD	PROCEDURE	REQUIREMENTS
			minute	ΔC/C
			Preheating: for size >1206: 100 °C to 120 °C for 1 minute and 170 °C to 200 °C for 1 minute	Class1: NP0: Within ±1% or 0.5 pF,
			Solder bath temperature: 260 ±5 °C	whichever is greater.
			Dipping time: 10 ±0.5 seconds	
			Recovery time: 24 ±2 hours	D.F. within initial specified value
				IR within initial specified value
Thermal Shock	AEC-Q200	16	I. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 \pm 1 hour at .	No visual damage
			room temp	ΔC/C
			2. Initial measure:	NP0: Within ±1% or 1 pF, whichever
			Spec: refer to initial spec C, D, IR	is greater
			3. Rapid change of temperature test:	
			NP0: -55 °C to +125 °C; 300 cycles	D.F: meet initial specified value
			15 minutes at lower category temperature; 15 minutes at upper category temperature.	IR meet initial specified value
			4. Recovery time:	
			Class I : 6 to 24 hours	
			Class2: 24 ±2 hours	
			5. Final measure: C, D, IR	
ESD	AEC-Q200	17	Per AEC-Q200-002	A component passes a voltage level if all components stressed at that voltage level pass.
Solderability	AEC-Q200	18	Preheated to a temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds.	The solder should cover over 95% of the critical area of each termination.
			Test conditions for lead containing solder alloy	
			Temperature: 235 ±5 °C	
			Dipping time: 2 ± 0.2 seconds	
			Depth of immersion: 10 mm	
			Alloy Composition: 60/40 Sn/Pb	
			Number of immersions: I	
			Test conditions for lead-free containing solder alloy	
			Temperature: 245 ±5 °C	
			Dipping time: 3 ±0.3 seconds	
			Depth of immersion: 10 mm	
			Alloy Composition: SAC305	
			Number of immersions: 1	
Electrical	AEC-Q200	19	Parametrically test per lot and sample size	ΔC/C
Characterization			requirements, summary to show Min, Max, Mean and	Class I:
			Standard deviation at room as well as Min and Max operating temperatures.	NP0: ±30 ppm/°C
			Class I:	
			NP0: -55 °C to +125 °C	
			Normal temperature: 20 °C	

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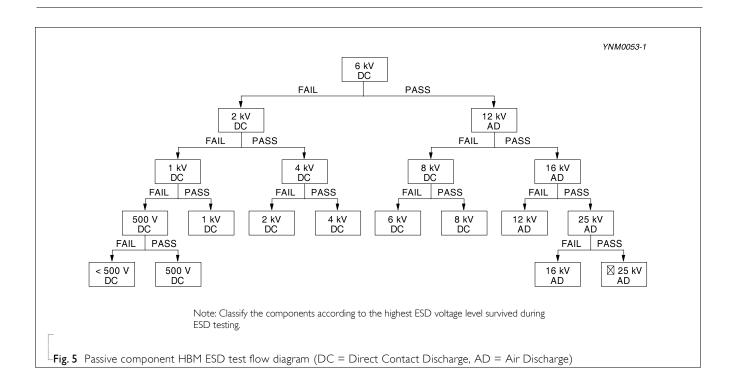
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TEST	TEST METH	IOD	PROCEDURE	REQUI	REMEN	ITS	
Board Flex	w P re C		Part mounted on a 100 mm X 40 mm FR4 PCB board, which is 1.6 ±0.2 mm thick and has a layer-thickness 35 µm ± 10 µm. Part should be mounted using the following soldering reflow profile. Conditions: Class I: Bending 3 mm at a rate of 1 mm/s, radius jig 340 mm	No visible damage $\Delta C/C$ Class I : NP0: Within ±1% or 0.5 pF, whichever is greater			
			Test Substrate:		Dimen	sion(m	m)
			<mark> ↔ b</mark> 04.5 ™	Туре	а	b	с
				0201	0.3	0.9	0.3
				0402	0.4	1.5	0.5
				0603	1.0	3.0	1.2
				0805	1.2	4.0	1.65
			+==+	1206	2.2	5.0	1.65
			100	1210	2.2	5.0	2.0
			unit: mm	1808	3.5	7.0	3.7
Terminal Strength	AEC-Q200	22	With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested. This force shall be applied for 60+1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested. * Apply 2N force for 0402 size.	be empl mechani body, te junction. Before, o	oyed fo ical inte rminals during a hall con nents st	or inspe grity of and bo and afte nply wi	or greater m ction of the the device ody/terminal er the test, t th all electri this
Beam Load Test	AEC-Q200	23	Place the part in the beam load fixture. Apply a force until the part breaks or the minimum acceptable force level required in the user specification(s) is attained.	≤ 0805 Thicknes Thicknes ≥ 1206 Thicknes Thicknes	ss ≤ 0.5 ss ≥1.25	mm: 81 5 mm: 5	N 54N
Voltage Proof			 Specified stress voltage applied for 1~5 seconds Ur ≤ 100 V: series applied 2.5 Ur 100 V < Ur ≤ 200 V series applied (1.5 Ur + 100) 200 V < Ur ≤ 500 V series applied (1.3 Ur + 100) Ur > 500 V: 1.3 Ur Ur ≥ 1000 V: 1.2 Ur Charge/Discharge current is less than 50 mA 	No brea	- Ikdown	or flasl	nover

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TEST							

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
ESR		Measuring frequency: 1 \pm 0.2GHz at room	$0.2pF \le C \le IpF: 350m\Omega / Cmax$
		temperature.	$IpF < C \leq 5pF: 300m\Omega$ max
			$5pF < C \leq 10pF : 250m\Omega$ max
			C : Nominal cap (pF)
		Measuring frequency: 500 \pm 50MHz at room temperature.	$10pF < C \leq 100pF$:400m Ω max



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<u>REVISION HISTORY</u>

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 0	Dec. 14, 2018	-	- New

YAGEO	Phicomp		Produ	
	Surface-Mount Ceramic Multilaver Canacitors	High Frequency	NP0	16 V to 50

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